

# Christophe Detavernier

## List of Publications by Year in descending order

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428  
papers

12,719  
citations

26567

56  
h-index

46693

89  
g-index

434  
all docs

434  
docs citations

434  
times ranked

11905  
citing authors

#	ARTICLE	IF	CITATIONS
1	Plasma-enhanced atomic layer deposition of nickel and cobalt phosphate for lithium ion batteries. Dalton Transactions, 2022, 51, 2059-2067.	1.6	3
2	Surface reactions between LiHMDS, TMA and TMP leading to deposition of amorphous lithium phosphate. Journal of Materials Chemistry A, 2022, 10, 3543-3551.	5.2	0
3	Atomic layer deposition of ternary ruthenates by combining metalorganic precursors with RuO <sub>4</sub> as the co-reactant. Dalton Transactions, 2022, 51, 10721-10727.	1.6	3
4	Selective Vapor-Phase Doping of Pt Nanoparticles into Phase-Controlled Nanoalloys. Journal of Physical Chemistry C, 2022, 126, 1426-1438.	1.5	4
5	Aligning time-resolved kinetics (TAP) and surface spectroscopy (AP-XPS) for a more comprehensive understanding of ALD-derived 2D and 3D model catalysts.. Faraday Discussions, 2022, , .	1.6	0
6	Atomic layer deposition of metal phosphates. Applied Physics Reviews, 2022, 9, .	5.5	7
7	Colloidal III-V Quantum Dot Photodiodes for Short-Wave Infrared Photodetection. Advanced Science, 2022, 9, e2200844.	5.6	31
8	Titanium Carboxylate Molecular Layer Deposited Hybrid Films as Protective Coatings for Lithium-Ion Batteries. ACS Applied Materials & Interfaces, 2022, 14, 24908-24918.	4.0	4
9	Shuffling Atomic Layer Deposition Gas Sequences to Modulate Bimetallic Thin Films and Nanoparticle Properties. Chemistry of Materials, 2022, 34, 6142-6154.	3.2	3
10	Properties of ultrathin molybdenum films for interconnect applications. Materialia, 2022, 24, 101511.	1.3	15
11	Tuning size and coverage of Pd nanoparticles using atomic layer deposition. Applied Surface Science, 2021, 539, 148238.	3.1	4
12	Converting molecular layer deposited alucone films into Al <sub>2</sub> O <sub>3</sub> /alucone hybrid multilayers by plasma densification. Dalton Transactions, 2021, 50, 1224-1232.	1.6	6
13	Impact of changes in bond structure on ovonic threshold switching behaviour in GeSe <sub>2</sub> . Journal of Materials Chemistry C, 2021, 9, 117-126.	2.7	6
14	Covalent graphite modification by low-temperature photocatalytic oxidation using a titanium dioxide thin film prepared by atomic layer deposition. Catalysis Science and Technology, 2021, 11, 6724-6731.	2.1	1
15	ALD Pt nanoparticles and thin-film coatings enhancing the stability and performance of silicon photocathodes for solar water splitting. Sustainable Energy and Fuels, 2021, 5, 3115-3123.	2.5	2
16	Emergence of Metallic Conductivity in Ordered One-Dimensional Coordination Polymer Thin Films upon Reductive Doping. ACS Applied Materials & Interfaces, 2021, 13, 10249-10256.	4.0	5
17	Acid-Base Mediated Ligand Exchange on Near-Infrared Absorbing, Indium-Based III-V Colloidal Quantum Dots. Journal of the American Chemical Society, 2021, 143, 4290-4301.	6.6	38
18	Waveguide-Coupled Colloidal Quantum Dot Light Emitting Diodes and Detectors on a Silicon Nitride Platform. Laser and Photonics Reviews, 2021, 15, 2000230.	4.4	16

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19	U(Mo) grain refinement induced by irradiation with high energy iodine. Journal of Nuclear Materials, 2021, 548, 152850.	1.3	4
20	Plasma enhanced atomic layer deposition of a (nitrogen doped) Ti phosphate coating for improved energy storage in Li-ion batteries. Journal of Power Sources, 2021, 497, 229866.	4.0	8
21	Atomic Layer Deposition on Polymer Thin Films: On the Role of Precursor Infiltration and Reactivity. ACS Applied Materials & Interfaces, 2021, 13, 46151-46163.	4.0	21
22	Plasma-enhanced atomic layer deposition: Correlating O <sub>2</sub> plasma parameters and species to blister formation and conformal film growth. Journal of Vacuum Science and Technology A: Vacuum, Surfaces and Films, 2021, 39, .	0.9	4
23	Ion beam modification of the Ni-Si solid-phase reaction: The influence of substrate damage and nitrogen impurities introduced by ion implantation. Journal Physics D: Applied Physics, 2021, 54, 015307.	1.3	6
24	An IR Spectroscopy Study of the Degradation of Surface Bound Azido-Groups in High Vacuum. Langmuir, 2021, 37, 12608-12615.	1.6	2
25	Tuning of the thermal stability and ovonic threshold switching properties of GeSe with metallic and non-metallic alloying elements. Journal of Applied Physics, 2021, 130, .	1.1	8
26	Controlled synthesis of Fe@Pt nanoalloys using atomic layer deposition. Nanotechnology, 2021, 32, 095602.	1.3	7
27	A limitation map of performance for porous electrodes in lithium-ion batteries. IScience, 2021, 24, 103496.	1.9	5
28	Thermal and Plasma-Enhanced Atomic Layer Deposition of Yttrium Oxide Films and the Properties of Water Wettability. ACS Applied Materials & Interfaces, 2020, 12, 3179-3187.	4.0	14
29	Atomic Layer Deposition of Indium@Tin@Oxide as Multifunctional Coatings on V <sub>2</sub> O <sub>5</sub> Thin-Film Model Electrode for Lithium-Ion Batteries. Advanced Materials Interfaces, 2020, 7, 2001022.	1.9	15
30	FeO controls the sintering of iron-based oxygen carriers in chemical looping CO <sub>2</sub> conversion. Journal of CO <sub>2</sub> Utilization, 2020, 40, 101216.	3.3	26
31	A Secondary Reaction Pathway for the Alumina Atomic Layer Deposition Process with Trimethylaluminum and Water, Revealed by Full-Range, Time-Resolved In Situ Mass Spectrometry. Journal of Physical Chemistry C, 2020, 124, 26443-26454.	1.5	8
32	Surface mobility and impact of precursor dosing during atomic layer deposition of platinum: <i>in situ</i> monitoring of nucleation and island growth. Physical Chemistry Chemical Physics, 2020, 22, 24917-24933.	1.3	19
33	Designing Nanoparticles and Nanoalloys for Gas-Phase Catalysis with Controlled Surface Reactivity Using Colloidal Synthesis and Atomic Layer Deposition. Molecules, 2020, 25, 3735.	1.7	10
34	Hierarchical Fe-modified MgAl <sub>2</sub> O <sub>4</sub> as a Ni-catalyst support for methane dry reforming. Catalysis Science and Technology, 2020, 10, 6987-7001.	2.1	22
35	Atomic Layer Deposition of SnO <sub>2</sub> -Based Composite Anodes for Thin-Film Lithium-Ion Batteries. Frontiers in Energy Research, 2020, 8, .	1.2	11
36	Reaction Pathways for Atomic Layer Deposition with Lithium Hexamethyl Disilazide, Trimethyl Phosphate, and Oxygen Plasma. Journal of Physical Chemistry C, 2020, 124, 27829-27839.	1.5	5

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37	Molecular Layer Deposition of "Magnesicone", a Magnesium-based Hybrid Material. <i>Chemistry of Materials</i> , 2020, 32, 4451-4466.	3.2	17
38	Atomic Layer Deposition of Nitrogen-Doped Al Phosphate Coatings for Li-Ion Battery Applications. <i>ACS Applied Materials &amp; Interfaces</i> , 2020, 12, 25949-25960.	4.0	14
39	Reaction mechanism of the $\text{Me}_3\text{AuPMe}_3\text{-H}_2$ plasma-enhanced ALD process. <i>Physical Chemistry Chemical Physics</i> , 2020, 22, 11903-11914.	1.3	2
40	Formation and preferential orientation of Au-free Al/Ti-based ohmic contacts on different hexagonal nitride-based heterostructures. <i>Journal of Applied Physics</i> , 2020, 127, 215701.	1.1	4
41	A liquid alkoxide precursor for the atomic layer deposition of aluminum oxide films. <i>Journal of Vacuum Science and Technology A: Vacuum, Surfaces and Films</i> , 2020, 38, .	0.9	3
42	Boosting Room-Temperature Magnetoionics in a Non-Magnetic Oxide Semiconductor. <i>Advanced Functional Materials</i> , 2020, 30, 2003704.	7.8	18
43	Plasmonic gold-embedded TiO <sub>2</sub> thin films as photocatalytic self-cleaning coatings. <i>Applied Catalysis B: Environmental</i> , 2020, 267, 118654.	10.8	61
44	Creation of gallium acid and platinum metal sites in bifunctional zeolite hydroisomerization and hydrocracking catalysts by atomic layer deposition. <i>Catalysis Science and Technology</i> , 2020, 10, 1778-1788.	2.1	13
45	Use of Neutron Absorbers to Influence the Neutron Transmutation Doping Process in Silicon. <i>Nuclear Technology</i> , 2020, 206, 758-765.	0.7	0
46	Ovonic Threshold-Switching $\text{Ge}_x\text{Se}_y$ Chalcogenide Materials: Stoichiometry, Trap Nature, and Material Relaxation from First Principles. <i>Physica Status Solidi - Rapid Research Letters</i> , 2020, 14, 1900672.	1.2	45
47	<i>In situ</i> study of the thermal stability of supported Pt nanoparticles and their stabilization <i>via</i> atomic layer deposition overcoating. <i>Nanoscale</i> , 2020, 12, 11684-11693.	2.8	8
48	Study of the surface species during thermal and plasma-enhanced atomic layer deposition of titanium oxide films using <i>in situ</i> IR-spectroscopy and <i>in vacuo</i> X-ray photoelectron spectroscopy. <i>Physical Chemistry Chemical Physics</i> , 2020, 22, 9262-9271.	1.3	18
49	The co-reactant role during plasma enhanced atomic layer deposition of palladium. <i>Physical Chemistry Chemical Physics</i> , 2020, 22, 9124-9136.	1.3	6
50	Atomic Layer Deposition of Localized Boron- and Hydrogen-Doped Aluminum Oxide Using Trimethyl Borate as a Dopant Precursor. <i>Chemistry of Materials</i> , 2020, 32, 4152-4165.	3.2	2
51	Mitigation of photon background in nanoplasmonic all-on-chip Raman sensors. <i>Optics Express</i> , 2020, 28, 33564.	1.7	8
52	(Invited) MLD of Metal-Organic Thin Films with Tunable Conductance for Neuromorphic Computing Applications. <i>ECS Meeting Abstracts</i> , 2020, MA2020-02, 1683-1683.	0.0	0
53	Aluminum tri-isopropoxide as an alternative precursor for atomic layer deposition of aluminum oxide thin films. <i>Journal of Vacuum Science and Technology A: Vacuum, Surfaces and Films</i> , 2019, 37, .	0.9	8
54	Stabilizing Fluoride Phosphors: Surface Modification by Atomic Layer Deposition. <i>Chemistry of Materials</i> , 2019, 31, 7192-7202.	3.2	42

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55	Atomic layer deposition of ZnO/SnO <sub>2</sub> composite thin film: The influence of structure, composition and crystallinity on lithium-ion battery performance. <i>Electrochimica Acta</i> , 2019, 320, 134604.	2.6	48
56	In Situ Photoluminescence of Colloidal Quantum Dots During Gas Exposure—The Role of Water and Reactive Atomic Layer Deposition Precursors. <i>ACS Applied Materials &amp; Interfaces</i> , 2019, 11, 26277-26287.	4.0	9
57	Setting Carriers Free: Healing Faulty Interfaces Promotes Delocalization and Transport in Nanocrystal Solids. <i>ACS Nano</i> , 2019, 13, 12774-12786.	7.3	22
58	Effectiveness of Ligand Denticity-Dependent Oxidation Protection in Copper MOD Inks. <i>Langmuir</i> , 2019, 35, 16101-16110.	1.6	7
59	Switchable Piezoresistive SmS Thin Films on Large Area. <i>Sensors</i> , 2019, 19, 4390.	2.1	8
60	Atomic layer deposition of thin films as model electrodes: A case study of the synergistic effect in Fe <sub>2</sub> O <sub>3</sub> -SnO <sub>2</sub> . <i>Journal of Vacuum Science and Technology A: Vacuum, Surfaces and Films</i> , 2019, 37, 050904.	0.9	5
61	Plasma-Enhanced Atomic Layer Deposition of Nanostructured Gold Near Room Temperature. <i>ACS Applied Materials &amp; Interfaces</i> , 2019, 11, 37229-37238.	4.0	12
62	CO <sub>2</sub> sorption properties of Li <sub>4</sub> SiO <sub>4</sub> with a Li <sub>2</sub> ZrO <sub>3</sub> coating. <i>Journal of CO<sub>2</sub> Utilization</i> , 2019, 34, 688-699.	3.3	16
63	Corrosion protection of Cu by atomic layer deposition. <i>Journal of Vacuum Science and Technology A: Vacuum, Surfaces and Films</i> , 2019, 37, 060902.	0.9	7
64	Impurity-enhanced solid-state amorphization: the Ni/Si thin film reaction altered by nitrogen. <i>Journal Physics D: Applied Physics</i> , 2019, 52, 145301.	1.3	8
65	Electron Transfer and Near-Field Mechanisms in Plasmonic Gold-Nanoparticle-Modified TiO <sub>2</sub> Photocatalytic Systems. <i>ACS Applied Nano Materials</i> , 2019, 2, 4067-4074.	2.4	34
66	Redox Layer Deposition of Thin Films of MnO <sub>2</sub> on Nanostructured Substrates from Aqueous Solutions. <i>Chemistry of Materials</i> , 2019, 31, 4805-4816.	3.2	18
67	Atomic layer deposition of vanadium oxides: process and application review. <i>Materials Today Chemistry</i> , 2019, 12, 396-423.	1.7	46
68	Fe <sub>2</sub> O <sub>3</sub> /MgAl <sub>2</sub> O <sub>4</sub> for CO Production from CO <sub>2</sub> : Mössbauer Spectroscopy and in Situ X-ray Diffraction. <i>ACS Sustainable Chemistry and Engineering</i> , 2019, 7, 9553-9565.	3.2	17
69	Selective electroless deposition of cobalt using amino-terminated SAMs. <i>Journal of Materials Chemistry C</i> , 2019, 7, 4392-4402.	2.7	21
70	Formation and Functioning of Bimetallic Nanocatalysts: The Power of X-ray Probes. <i>Angewandte Chemie - International Edition</i> , 2019, 58, 13220-13230.	7.2	31
71	Photocatalytic Lithography with Atomic Layer-Deposited TiO <sub>2</sub> Films to Tailor Biointerface Properties. <i>Advanced Materials Interfaces</i> , 2019, 6, 1900035.	1.9	7
72	Formation and Functioning of Bimetallic Nanocatalysts: The Power of X-ray Probes. <i>Angewandte Chemie</i> , 2019, 131, 13354-13364.	1.6	6

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73	Nucleation Enhancement and Area-Selective Atomic Layer Deposition of Ruthenium Using RuO <sub>4</sub> and H <sub>2</sub> Gas. Chemistry of Materials, 2019, 31, 1491-1499.	3.2	36
74	Plasma enhanced atomic layer deposition of gallium sulfide thin films. Journal of Vacuum Science and Technology A: Vacuum, Surfaces and Films, 2019, 37, .	0.9	16
75	Ligand Binding to Copper Nanocrystals: Amines and Carboxylic Acids and the Role of Surface Oxides. Chemistry of Materials, 2019, 31, 2058-2067.	3.2	24
76	Ultra-thin sub-10nm Ga <sub>2</sub> O <sub>3</sub> -WO <sub>3</sub> heterostructures developed by atomic layer deposition for sensitive and selective C <sub>2</sub> H <sub>5</sub> OH detection on ppm level. Sensors and Actuators B: Chemical, 2019, 287, 147-156.	4.0	41
77	Chemical and Structural Configuration of Pt-Doped Metal Oxide Thin Films Prepared by Atomic Layer Deposition. Chemistry of Materials, 2019, 31, 9673-9683.	3.2	8
78	Assessing stability of metal tellurides as alternative photomask materials for extreme ultraviolet lithography. Journal of Vacuum Science and Technology B: Nanotechnology and Microelectronics, 2019, 37, 061607.	0.6	8
79	Bifunctional earth-abundant phosphate/phosphide catalysts prepared <i>via</i> atomic layer deposition for electrocatalytic water splitting. Nanoscale Advances, 2019, 1, 4166-4172.	2.2	24
80	Micro-Transfer-Printing of Al <sub>2</sub> O <sub>3</sub> -Capped Short-Wave-Infrared PbS Quantum Dot Photoconductors. ACS Applied Nano Materials, 2019, 2, 299-306.	2.4	14
81	Near Room Temperature PE-ALD of Nanostructured Gold for Enhanced Raman Scattering. ECS Meeting Abstracts, 2019, , .	0.0	0
82	Impact of Atomic Layer Deposition on the Photoluminescence of Colloidal Quantum Dots. ECS Meeting Abstracts, 2019, , .	0.0	0
83	(Invited) A Tutorial on Atomic Layer Deposition and Its Application in Lithium-Ion Batteries. ECS Meeting Abstracts, 2019, , .	0.0	0
84	(Invited) ALD and MLD of Functional Thin-Film Coatings for Enhanced Performance in Li-Ion and Li-Metal Solid-State Batteries. ECS Meeting Abstracts, 2019, , .	0.0	0
85	Catalyst-assisted chemical looping auto-thermal dry reforming: Spatial structuring effects on process efficiency. Applied Catalysis B: Environmental, 2018, 231, 123-136.	10.8	48
86	Controlling the formation and stability of ultra-thin nickel silicides - An alloying strategy for preventing agglomeration. Journal of Applied Physics, 2018, 123, .	1.1	21
87	The transformation behaviour of $\alpha$ -alumina, deposited by molecular layer deposition, in nanoporous Al <sub>2</sub> O <sub>3</sub> layers. Dalton Transactions, 2018, 47, 5860-5870.	1.6	40
88	Influence of the Chalcogen Element on the Filament Stability in CuIn(Te,Se,S) <sub>2</sub> /Al <sub>2</sub> O <sub>3</sub> Filamentary Switching Devices. ACS Applied Materials & Interfaces, 2018, 10, 14835-14842.	4.0	4
89	TiO <sub>2</sub> -coated luminescent porous silicon micro-particles as a promising system for nanomedicine. Journal of Materials Chemistry B, 2018, 6, 1815-1824.	2.9	15
90	Plasma enhanced atomic layer deposition of aluminum sulfide thin films. Journal of Vacuum Science and Technology A: Vacuum, Surfaces and Films, 2018, 36, .	0.9	22

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91	PdZn nanoparticle catalyst formation for ethanol dehydrogenation: Active metal impregnation vs incorporation. Applied Catalysis A: General, 2018, 555, 12-19.	2.2	16
92	Bifunctional Co- and Ni- ferrites for catalyst-assisted chemical looping with alcohols. Applied Catalysis B: Environmental, 2018, 222, 59-72.	10.8	36
93	Surface species during ALD of platinum observed with <i>in situ</i> reflection IR spectroscopy. Physical Chemistry Chemical Physics, 2018, 20, 25343-25356.	1.3	20
94	Voltage-Controlled ON/OFF Ferromagnetism at Room Temperature in a Single Metal Oxide Film. ACS Nano, 2018, 12, 10291-10300.	7.3	57
95	Axiotaxy and epitaxial textures in $C_{54}$ -TiSi <sub>2</sub> films on Si(001) and Si(111) substrates. Journal of Applied Physics, 2018, 51, 445302.	1.3	5
96	ALD assisted nanoplasmonic slot waveguide for on-chip enhanced Raman spectroscopy. APL Photonics, 2018, 3, .	3.0	35
97	Effect of thermal annealing and chemical treatments on secondary electron emission properties of atomic layer deposited MgO. Journal of Vacuum Science and Technology A: Vacuum, Surfaces and Films, 2018, 36, 06A102.	0.9	9
98	Fe-Containing Magnesium Aluminate Support for Stability and Carbon Control during Methane Reforming. ACS Catalysis, 2018, 8, 5983-5995.	5.5	66
99	Oxidation barrier of Cu and Fe powder by Atomic Layer Deposition. Surface and Coatings Technology, 2018, 349, 1032-1041.	2.2	12
100	Kinetics of Lifetime Changes in Bimetallic Nanocatalysts Revealed by Quick X-ray Absorption Spectroscopy. Angewandte Chemie - International Edition, 2018, 57, 12430-12434.	7.2	15
101	Red Mn <sup>4+</sup> -Doped Fluoride Phosphors: Why Purity Matters. ACS Applied Materials & Interfaces, 2018, 10, 18845-18856.	4.0	74
102	The influence of alloying on the phase formation sequence of ultra-thin nickel silicide films and on the inheritance of texture. Journal of Applied Physics, 2018, 123, 185302.	1.1	14
103	Kinetics of Lifetime Changes in Bimetallic Nanocatalysts Revealed by Quick X-ray Absorption Spectroscopy. Angewandte Chemie, 2018, 130, 12610-12614.	1.6	2
104	Annealing of thin $\epsilon$ -Tinone films, a tin-based hybrid material deposited by molecular layer deposition, in reducing, inert, and oxidizing atmospheres. Journal of Vacuum Science and Technology A: Vacuum, Surfaces and Films, 2018, 36, 051506.	0.9	16
105	Pore pressure estimation in irradiated UMo. Journal of Nuclear Materials, 2018, 510, 472-483.	1.3	22
106	(Invited) Atomic Layer Deposition for Interface Engineering of (Thin-Film) Lithium-Ion Battery. ECS Meeting Abstracts, 2018, , .	0.0	0
107	Synthesis of 3D Porous Nanostructured Platinum Using Atomic Layer Deposition. ECS Meeting Abstracts, 2018, , .	0.0	0
108	Inherent Area-Selective Growth and Nucleation Enhancement during Ru ALD Using the RuO <sub>4</sub> -Precursor and H <sub>2</sub> -Gas. ECS Meeting Abstracts, 2018, MA2018-02, 984-984.	0.0	1

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109	(Invited) Red Fluoride Phosphors: A Story of Reliability. ECS Meeting Abstracts, 2018, , .	0.0	0
110	Electrodeposition of Adherent MnO <sub>2</sub> Films with Optimized Current Collector Interface for 3D Li-Ion Electrodes. ECS Meeting Abstracts, 2018, , .	0.0	0
111	Silver-polymer core-shell nanoparticles for ultrastable plasmon-enhanced photocatalysis. Applied Catalysis B: Environmental, 2017, 200, 31-38.	10.8	48
112	Atomic layer deposition-enabled single layer of tungsten trioxide across a large area. Applied Materials Today, 2017, 6, 44-53.	2.3	52
113	Heterogeneous TiO <sub>2</sub> /V <sub>2</sub> O <sub>5</sub> /Carbon Nanotube Electrodes for Lithium-Ion Batteries. ACS Applied Materials & Interfaces, 2017, 9, 8055-8064.	4.0	32
114	Controlling the stability of a Fe-Ni reforming catalyst: Structural organization of the active components. Applied Catalysis B: Environmental, 2017, 209, 405-416.	10.8	89
115	The role of composition and microstructure in Ni-W silicide formation and low temperature epitaxial NiSi <sub>2</sub> growth by premixing Si. Journal Physics D: Applied Physics, 2017, 50, 065303.	1.3	3
116	Molecular layer deposition of $\delta$ -vanadone, a vanadium-based hybrid material, as an electrode for lithium-ion batteries. Dalton Transactions, 2017, 46, 4542-4553.	1.6	42
117	Monte Carlo simulations of atomic layer deposition on 3D large surface area structures: Required precursor exposure for pillar- versus hole-type structures. Journal of Vacuum Science and Technology A: Vacuum, Surfaces and Films, 2017, 35, .	0.9	24
118	Amorphous and Crystalline Vanadium Oxides as High-Energy and High-Power Cathodes for Three-Dimensional Thin-Film Lithium Ion Batteries. ACS Applied Materials & Interfaces, 2017, 9, 13121-13131.	4.0	73
119	Size- and composition-controlled Pt-Sn bimetallic nanoparticles prepared by atomic layer deposition. RSC Advances, 2017, 7, 20201-20205.	1.7	12
120	The Influence of Ultrathin Amorphous ALD Alumina and Titania on the Rate Capability of Anatase TiO <sub>2</sub> and LiMn <sub>2</sub> O <sub>4</sub> Lithium Ion Battery Electrodes. Advanced Materials Interfaces, 2017, 4, 1601237.	1.9	50
121	Ternary silicide formation from Ni-Pt, Ni-Pd and Pt-Pd alloys on Si(100): Nucleation and solid solubility of the monosilicides. Acta Materialia, 2017, 130, 19-27.	3.8	9
122	Plasma enhanced atomic layer deposition of zinc sulfide thin films. Journal of Vacuum Science and Technology A: Vacuum, Surfaces and Films, 2017, 35, .	0.9	21
123	K <sub>2</sub> MnF <sub>6</sub> as a precursor for saturated red fluoride phosphors: the struggle for structural stability. Journal of Materials Chemistry C, 2017, 5, 10761-10769.	2.7	34
124	(Invited) Atomic Layer Deposition of Nanoalloys of Noble and Non-Noble Metals. ECS Transactions, 2017, 80, 97-106.	0.3	1
125	Independent tuning of size and coverage of supported Pt nanoparticles using atomic layer deposition. Nature Communications, 2017, 8, 1074.	5.8	95
126	Sensing the framework state and guest molecules in MIL-53(Al) via the electron paramagnetic resonance spectrum of V <sup>IV</sup> dopant ions. Physical Chemistry Chemical Physics, 2017, 19, 24545-24554.	1.3	24



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127	Key role of surface oxidation and reduction processes in the coarsening of Pt nanoparticles. <i>Nanoscale</i> , 2017, 9, 13159-13170.	2.8	25
128	Plasma-enhanced atomic layer deposition of vanadium phosphate as a lithium-ion battery electrode material. <i>Journal of Vacuum Science and Technology A: Vacuum, Surfaces and Films</i> , 2017, 35, .	0.9	12
129	Formation of ultrathin Ni germanides: solid-phase reaction, morphology and texture. <i>Journal Physics D: Applied Physics</i> , 2017, 50, 455301.	1.3	6
130	A USB-controlled potentiostat/galvanostat for thin-film battery characterization. <i>HardwareX</i> , 2017, 2, 34-49.	1.1	76
131	Axiotaxy in oxide heterostructures: Preferential orientation of BaCeO <sub>3</sub> nanoparticles embedded in superconducting YBa <sub>2</sub> Cu <sub>3</sub> O <sub>7-<math>\delta</math></sub> thin films. <i>Thin Solid Films</i> , 2017, 638, 105-113.	0.8	3
132	Formation and stability of an active PdZn nanoparticle catalyst on a hydrotalcite-based support for ethanol dehydrogenation. <i>Catalysis Science and Technology</i> , 2017, 7, 3715-3727.	2.1	12
133	Plasma-Enhanced Atomic Layer Deposition of Silver Using Ag(fod)(PEt <sub>3</sub> ) and NH <sub>3</sub> -Plasma. <i>Chemistry of Materials</i> , 2017, 29, 7114-7121.	3.2	20
134	Electrodeposition of Adherent Submicron to Micron Thick Manganese Dioxide Films with Optimized Current Collector Interface for 3D Li-Ion Electrodes. <i>Journal of the Electrochemical Society</i> , 2017, 164, D954-D963.	1.3	14
135	Plasmonic Near-Field Localization of Silver Core-Shell Nanoparticle Assemblies via Wet Chemistry Nanogap Engineering. <i>ACS Applied Materials &amp; Interfaces</i> , 2017, 9, 41577-41585.	4.0	34
136	Microwave induced $\beta$ -structure in Cr/V-MIL-53. <i>Chemical Communications</i> , 2017, 53, 8478-8481.	2.2	33
137	3D porous nanostructured platinum prepared using atomic layer deposition. <i>Journal of Materials Chemistry A</i> , 2017, 5, 19007-19016.	5.2	10
138	A core-shell structured Fe <sub>2</sub> O <sub>3</sub> /ZrO <sub>2</sub> @ZrO <sub>2</sub> nanomaterial with enhanced redox activity and stability for CO <sub>2</sub> conversion. <i>Journal of CO<sub>2</sub> Utilization</i> , 2017, 17, 20-31.	3.3	41
139	Tuning the switching behavior of conductive-bridge resistive memory by the modulation of the cation-supplier alloys. <i>Microelectronic Engineering</i> , 2017, 167, 47-51.	1.1	8
140	Plasma-enhanced atomic layer deposition of titanium phosphate as an electrode for lithium-ion batteries. <i>Journal of Materials Chemistry A</i> , 2017, 5, 330-338.	5.2	31
141	Perpendicular magnetic anisotropy of CoFeB/Ta bilayers on ALD HfO <sub>2</sub> . <i>AIP Advances</i> , 2017, 7, 055933.	0.6	8
142	Doped GeSe materials for selector applications. , 2017, , .		18
143	Wet-Chemical Synthesis of 3D Stacked Thin Film Metal-Oxides for All-Solid-State Li-Ion Batteries. <i>Materials</i> , 2017, 10, 1072.	1.3	0
144	(Invited) Ultrathin Epitaxial Silicides for Semiconductor Contacts. <i>ECS Meeting Abstracts</i> , 2017, , .	0.0	0

#	ARTICLE	IF	CITATIONS
145	Molecular Layer Deposition for Applications in Lithium-Ion Batteries. ECS Meeting Abstracts, 2017, , .	0.0	0
146	(Invited) Atomic Layer Deposition of Nanoalloys of Noble and Non-Noble Metals. ECS Meeting Abstracts, 2017, , .	0.0	0
147	Conformal Vanadium Oxides Beyond Crystalline V <sub>2</sub> O <sub>5</sub> As High Energy Density 3D Thin-Film Electrodes for Lithium-Ion Batteries. ECS Meeting Abstracts, 2017, , .	0.0	0
148	Atomic Layer Deposition of Pt Nanoparticles within the Cages of MIL-101: A Mild and Recyclable Hydrogenation Catalyst. Nanomaterials, 2016, 6, 45.	1.9	38
149	Direct Imaging of ALD Deposited Pt Nanoclusters inside the Giant Pores of MIL-101. Particle and Particle Systems Characterization, 2016, 33, 382-387.	1.2	28
150	<i>In Situ</i> Electron Paramagnetic Resonance and X-ray Diffraction Monitoring of Temperature-Induced Breathing and Related Structural Transformations in Activated V-Doped MIL-53(Al). Journal of Physical Chemistry C, 2016, 120, 17400-17407.	1.5	26
151	Chemically Triggered Formation of Two-Dimensional Epitaxial Quantum Dot Superlattices. ACS Nano, 2016, 10, 6861-6870.	7.3	49
152	Mobile setup for synchrotron based <i>in situ</i> characterization during thermal and plasma-enhanced atomic layer deposition. Review of Scientific Instruments, 2016, 87, 113905.	0.6	21
153	Phase formation and texture of thin nickel germanides on Ge(001) and Ge(111). Journal of Applied Physics, 2016, 119, .	1.1	16
154	Anisotropic thermal expansion of Ni, Pd and Pt germanides and silicides. Journal Physics D: Applied Physics, 2016, 49, 275307.	1.3	4
155	Texture in thin film silicides and germanides: A review. Applied Physics Reviews, 2016, 3, 031302.	5.5	30
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160	Deactivation Study of Fe <sub>2</sub> O <sub>3</sub> •CeO <sub>2</sub> during Redox Cycles for CO Production from CO <sub>2</sub> . Industrial & Engineering Chemistry Research, 2016, 55, 5911-5922.	1.8	56
161	Hydroisomerization and hydrocracking activity enhancement of a hierarchical ZSM-5 zeolite catalyst via atomic layer deposition of aluminium. Catalysis Science and Technology, 2016, 6, 6177-6186.	2.1	15
162	Atomic Layer Deposition Route To Tailor Nanoalloys of Noble and Non-noble Metals. ACS Nano, 2016, 10, 8770-8777.	7.3	44

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164	A Case Study of ALD Encapsulation of Quantum Dots: Embedding Supported CdSe/CdS/ZnS Quantum Dots in a ZnO Matrix. Journal of Physical Chemistry C, 2016, 120, 18039-18045.	1.5	33
165	Electro-precipitation via oxygen reduction: a new technique for thin film manganese oxide deposition. Journal of Materials Chemistry A, 2016, 4, 13555-13562.	5.2	2
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167	Manganese oxide films with controlled oxidation state for water splitting devices through a combination of atomic layer deposition and post-deposition annealing. RSC Advances, 2016, 6, 98337-98343.	1.7	44
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173	Understanding the Dual Nature of the Filament Dissolution in Conductive Bridging Devices. Journal of Physical Chemistry Letters, 2015, 6, 1919-1924.	2.1	61
174	Conductive filaments multiplicity as a variability factor in CBRAM. , 2015, , .		8
175	Atomic layer deposited second-order nonlinear optical metamaterial for back-end integration with CMOS-compatible nanophotonic circuitry. Optics Letters, 2015, 40, 5371.	1.7	27
176	Influence of alloying the copper supply layer on the retention of CBRAM. , 2015, , .		4
177	Modification of Ultra Low-k Dielectric Films by O <sub>2</sub> and CO <sub>2</sub> Plasmas. ECS Journal of Solid State Science and Technology, 2015, 4, N3048-N3057.	0.9	5
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183	Combinatorial Study of Ag <sup>+</sup> Te Thin Films and Their Application as Cation Supply Layer in CBRAM Cells. ACS Combinatorial Science, 2015, 17, 334-340.	3.8	24
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194	Magnetic characterization and electrical field-induced switching of magnetite thin films synthesized by atomic layer deposition and subsequent thermal reduction. Journal Physics D: Applied Physics, 2014, 47, 485001.	1.3	19
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248	Three dimensional reciprocal space measurement by x-ray diffraction using linear and area detectors: Applications to texture and defects determination in oriented thin films and nanoprecipitates. <i>Journal of Vacuum Science and Technology A: Vacuum, Surfaces and Films</i> , 2013, 31, 021505.	0.9	21
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277	Semiconductor-metal transition in thin VO <sub>2</sub> films grown by ozone based atomic layer deposition. <i>Applied Physics Letters</i> , 2011, 98, .	1.5	78
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291	Annealing induced hysteresis suppression for TiN/HfO <sub>2</sub> /GeON/p-Ge capacitor. <i>Semiconductor Science and Technology</i> , 2011, 26, 125003.	1.0	8
292	TiO <sub>2</sub> /HfO <sub>2</sub> Bi-Layer Gate Stacks Grown by Atomic Layer Deposition for Germanium-Based Metal-Oxide-Semiconductor Devices Using GeOxNy Passivation Layer. <i>Electrochemical and Solid-State Letters</i> , 2011, 14, G27.	2.2	14
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